

Ceramic Plate Series CP08,127,05

Thermoelectric Modules

The Ceramic Plate (CP) Series of Thermoelectric Modules (TEMs) is considered 'the standard' in the thermoelectric industry.

This broad product line of high-performance and highly reliable TEMs is available in numerous heat pumping capacities, geometric shapes, and input power ranges. Assembled with Bismuth Telluride semiconductor material and thermally conductive Aluminum Oxide ceramics, the CP Series is designed for higher current and large heat-pumping applications.

FEATURES

- Precise Temperature Control
- Compact Geometric Sizes
- Reliable Solid State Operation
- No Sound or Vibration
- Environmentally Friendly
- DC Operation
- RoHS Compliant

APPLICATIONS

- Medical Lasers
- Lab Science Instrumentation
- Clinical Diagnostic Systems
- Photonics Laser Systems
- Electronic Enclosure Cooling
- Food & Beverage Cooling
- Chillers (Liquid Cooling)

PERFORMANCE SPECIFICATIONS

Hot Side Temperature (°C)	25°C	50°C
Qmax (Watts)	22.6	24.8
Delta Tmax (°C)	67	75
I _{max} (Amps)	2.6	2.6
V _{max} (Volts)	14.4	16.4
Module Resistance (Ohms)	5.10	5.75

SUFFIX	THICKNESS (PRIOR TO TINNING)	FLATNESS & PARALLELISM	HOT FACE	COLD FACE	Lead Length
L1	0.122" ± 0.001"	0.001" / 0.001"	Lapped	Lapped	4.5"
L2	0.122" ± 0.0005"	0.0005" / 0.0005"	Lapped	Lapped	4.5"
ML	0.127" ± 0.010"	0.002" / 0.002"	Metallized	Lapped	4.5"
LM	0.127" ± 0.010"	0.002" / 0.002"	Lapped	Metallized	4.5"
MM	0.132" ± 0.010"	0.002" / 0.002"	Metallized	Metallized	4.5"

SEALING OPTION

SUFFIX	SEALANT	COLOR	TEMP RANGE	DESCRIPTION
RT	RTV	White	-60 to 204 °C	Non-corrosive, silicone adhesive sealant
EP	Epoxy	Black	-55 to 150 °C	Low density syntactic foam epoxy encapsulant

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Americas: +1 888.246.9050

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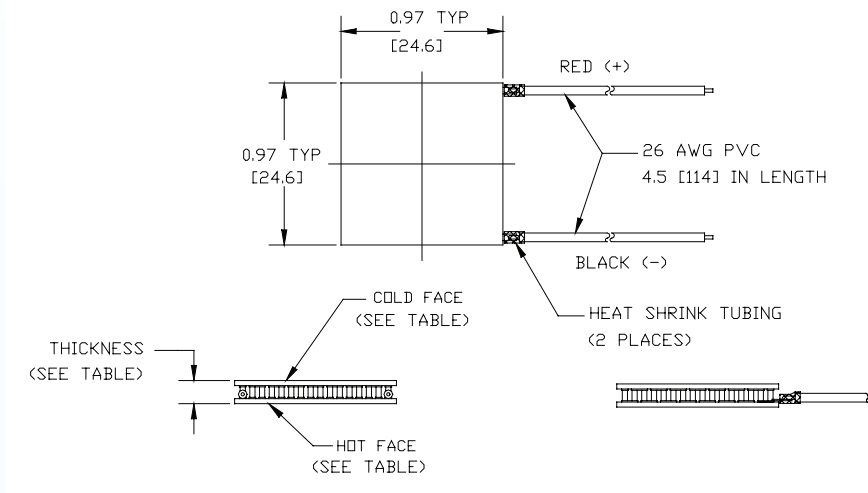
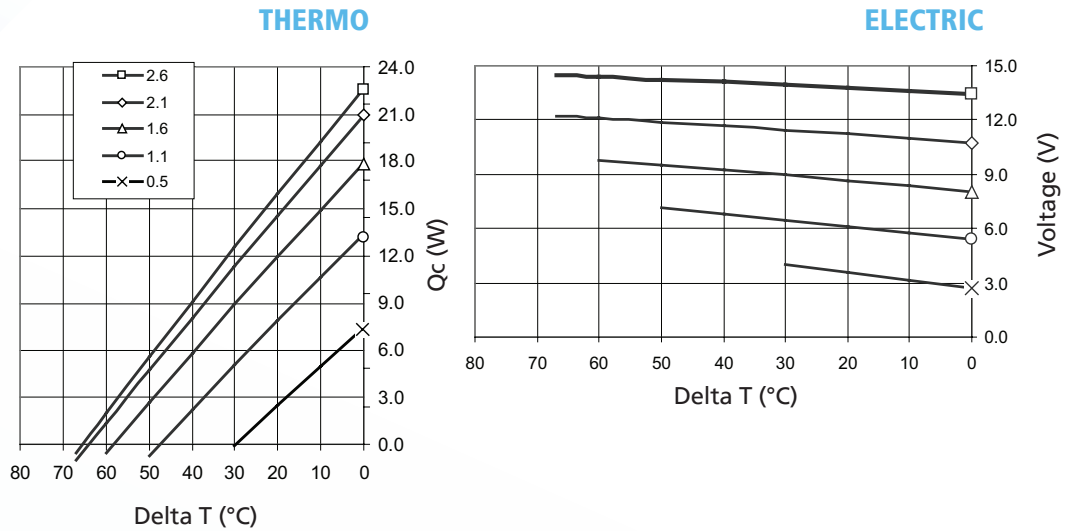
Asia: +86.755.2714.1166

clv.customerpos@lairdtech.com

www.lairdtech.com

Ceramic Plate Series CP08,127,05 Thermoelectric Modules

Performance Curves at $T_h = 25^\circ\text{C}$



Ceramic Material: Alumina (Al_2O_3)
Solder Construction: 138°C , Bismuth Tin (BiSn)

OPERATING TIPS

- Max Operating Temperature: 80°C
- Do not exceed I_{max} or V_{max} when operating module
- Reference assembly guidelines for recommended installation
- Solder tinning also available on metallized ceramics

THR-DS-CP08,127,05 0111

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9